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General-Purpose Rectifiers (Glass Passivated)

S2A-S2M

Description

The S2 family of devices are general-purpose 2 A rated rectifiers with voltage ratings ranging from 50 to 1000 V. They are implemented in traditional SMB packages and are well known to the industry. For advanced or special requirements, please contact an onsemi representative.

Features

- High-Current Capability, 2 A Rated
- Fast Response: 2 μ s T_{rr}
- Low-Forward Voltage Drop, 1.15 V V_F Max at 2 A
- High-Surge Current Capability, 50 A²s I_{FSM}
- Glass Passivated Junction
- UL Certified, UL #E258596
- NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

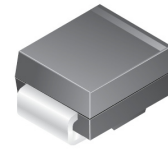
Applications

- Power Supplies
- AC to DC Rectification
- Bypass Diodes

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

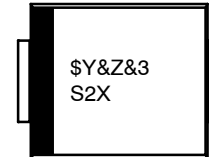
Symbol	Parameter	Value							Unit
		S2A	S2B	S2D	S2G	S2J	S2K	S2M	
V_{RRM}	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
$I_{F(AV)}$	Average Rectified Forward Current at $T_A = 100^\circ\text{C}$	2.0							A
I_{FSM}	Non-Repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine Wave	50							A
T_{STG}	Storage Temperature Range	-65 to +150							$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-65 to +150							$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



SMB
CASE 403AF

MARKING DIAGRAM



\$Y	= onsemi Logo
&Z	= Assembly Plant Code
&3	= Numeric Date Code
S2X	= Specific Device Code
X	= A-M

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 2.

S2A–S2M

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Value	Unit
P_D	Power Dissipation	2.35	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1)	53	$^\circ\text{C}/\text{W}$

1. Device is mounted on FR–4 PCB 0.013 mm.

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Value						Unit
			S2A	S2B	S2D	S2G	S2J	S2K	
V _F	Maximum Forward Voltage	I _F = 2.0 A	1.15						V
t _{rr}	Typical Reverse–Recovery Time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A	2.0						μs
I _R	Maximum Reverse Current at Rated V _R	T _A = 25°C	1.0						μA
		T _A = 125°C	125						
C _T	Typical Total Capacitance	V _R = 4.0 V, f = 1.0 MHz	30						pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ORDERING INFORMATION

Part Number	Marking	Package	Shipping [†]
S2B, NRVS2B*	S2B	SMB (Pb–Free)	3000 / Tape & Reel
S2D, NRVS2D*	S2D		
S2M, NRVS2M*	S2M		

DISCONTINUED (Note 2)

Part Number	Marking	Package	Shipping [†]
S2A, NRVS2A*	S2A	SMB (Pb–Free)	3000 / Tape & Reel
S2G, NRVS2G*	S2G		
S2J, NRVS2J*	S2J		
S2K, NRVS2K*	S2K		

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NRV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

2. **DISCONTINUED:** These devices are not recommended for new design. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.

TYPICAL PERFORMANCE CHARACTERISTICS

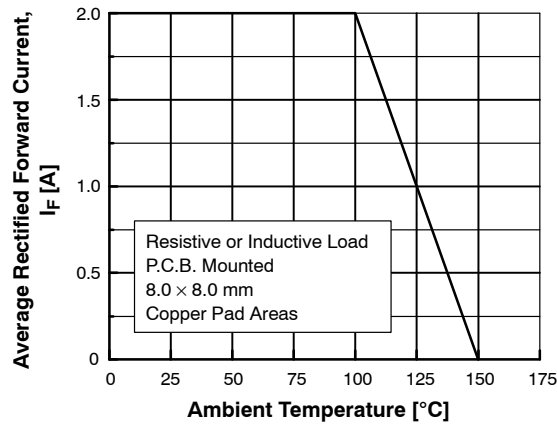


Figure 1. Forward Current Derating Curve

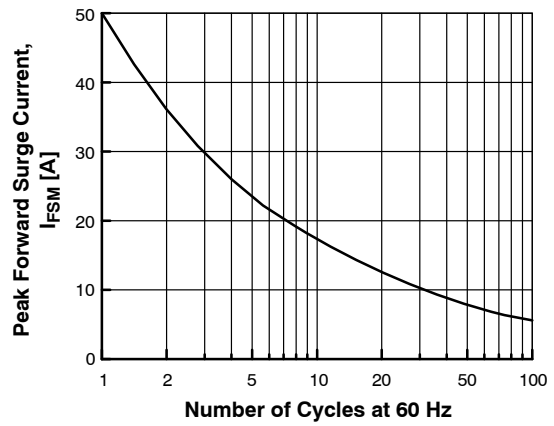


Figure 2. Non-Repetitive Surge Current

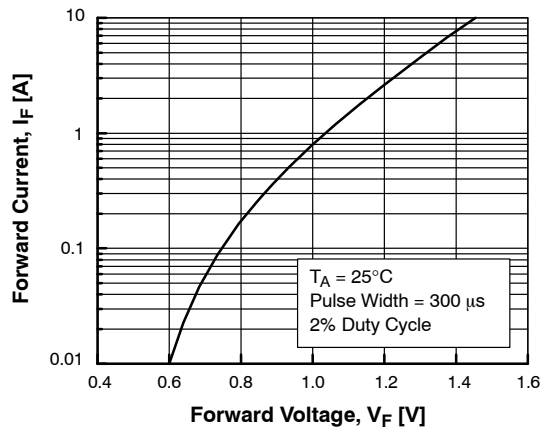


Figure 3. Forward Voltage Characteristics

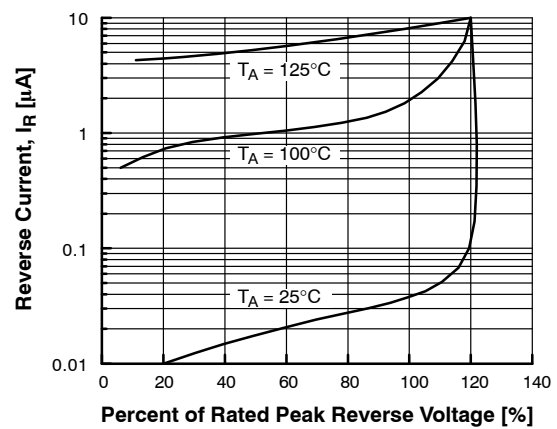


Figure 4. Reverse Current vs. Reverse Voltage

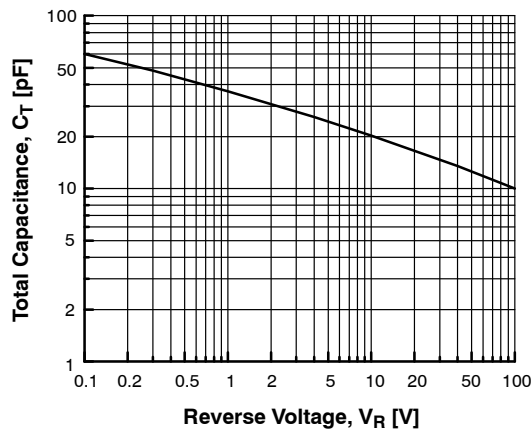
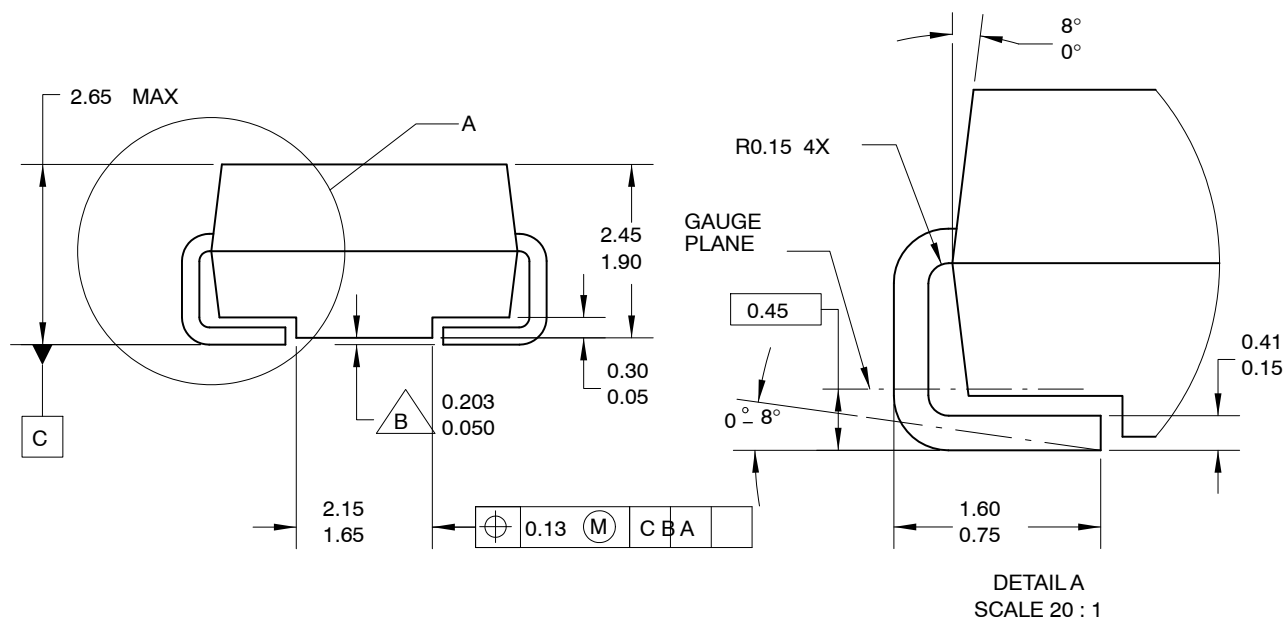
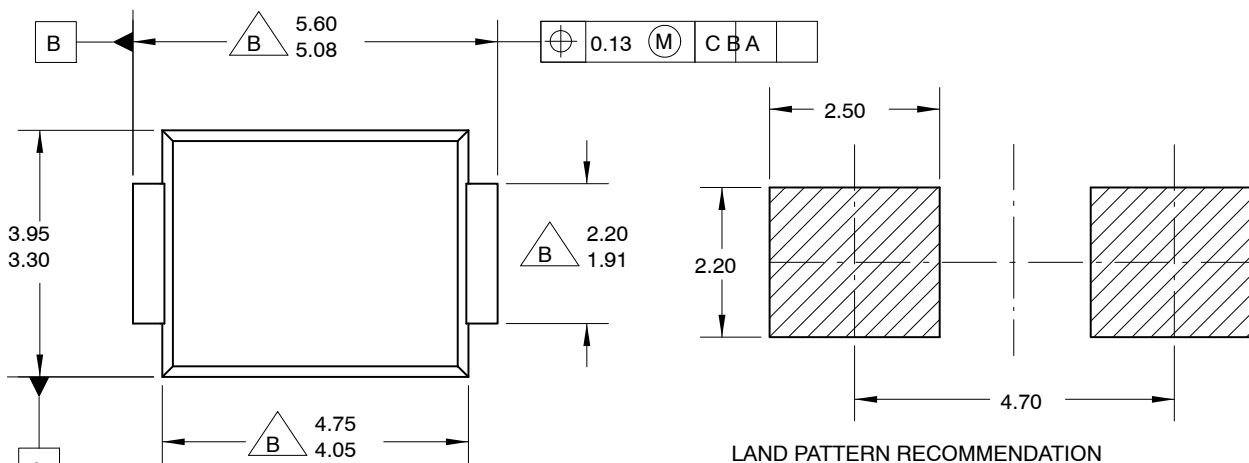


Figure 5. Total Capacitance

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NOTES:

- A. EXCEPT WHERE NOTED CONFORMS TO JEDEC DO214 VARIATION AA.
☒ B. DOES NOT COMPLY JEDEC STD. VALUE.
 C. ALL DIMENSIONS ARE IN MILLIMETERS.
 D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
 E. DIMENSION AND TOLERANCE AS PER ASME Y14.5-1994.
 F. LAND PATTERN STD. DIOM5336X240M.

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